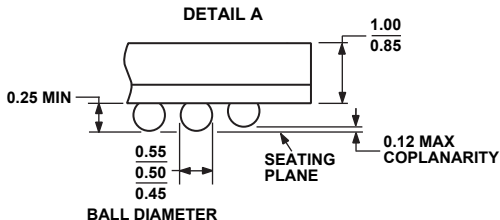
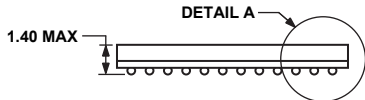
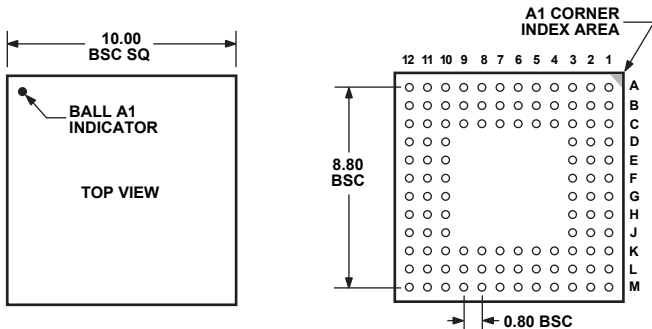


**108-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-108-1)**

Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MO-205-AC